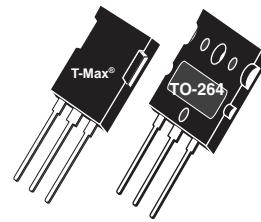
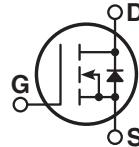




Super Junction MOSFET

- Ultra Low $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge, Q_g
- Avalanche Energy Rated
- Extreme dV/dt Rated

Unless stated otherwise, Microsemi discrete MOSFETs contain a single MOSFET die. This device is made with two parallel MOSFET die. It is intended for switch-mode operation. It is not suitable for linear mode operation.

APT97N65B2C6

APT97N65LC6


MAXIMUM RATINGS

 All Ratings per die: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	AP97N65B2_LC6	UNIT
V_{DSS}	Drain-Source Voltage	650	Volts
I_D	Continuous Drain Current @ $T_C = 25^\circ\text{C}$ ¹ (assuming $R_{DS(on)} \text{ max} = 0.041\Omega$)	97	Amps
	Continuous Drain Current @ $T_C = 100^\circ\text{C}$	62	
I_{DM}	Pulsed Drain Current ²	291	
V_{GS}	Gate-Source Voltage Continuous	± 20	Volts
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	862	Watts
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 - to 150	$^\circ\text{C}$
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	260	
I_{AR}	Avalanche Current ²	13.4	Amps
E_{AR}	Repetitive Avalanche Energy ³ ($I_d = 13.4\text{A}$, $V_{DD} = 50\text{V}$)	2.96	
E_{AS}	Single Pulse Avalanche Energy ($I_d = 13.4\text{A}$, $V_{DD} = 50\text{V}$)	1954	mJ

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{(DSS)}$	Drain-Source Breakdown Voltage ($V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$)	650			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance ⁴ ($V_{GS} = 10\text{V}$, $I_D = 48.5\text{A}$)		0.037	0.041	Ohms
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = 650\text{V}$, $V_{GS} = 0\text{V}$)			25	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 650\text{V}$, $V_{GS} = 0\text{V}$, $T_C = 150^\circ\text{C}$)			250	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$)			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 2.96\text{mA}$)	2.5	3	3.5	Volts

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

APT97N65B2_LC6

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		7650		pF
C_{oss}	Output Capacitance			5045		
C_{rss}	Reverse Transfer Capacitance			550		
Q_g	Total Gate Charge ^⑤	$V_{GS} = 10V$ $V_{DD} = 325V$ $I_D = 97A @ 25^\circ C$		300		nC
Q_{gs}	Gate-Source Charge			50		
Q_{gd}	Gate-Drain ("Miller") Charge			160		
$t_{d(on)}$	Turn-on Delay Time			25		
t_r	Rise Time	INDUCTIVE SWITCHING $V_{GS} = 15V$ $V_{DD} = 433V$ $I_D = 97A @ 25^\circ C$		60		ns
$t_{d(off)}$	Turn-off Delay Time			275		
t_f	Fall Time	$R_G = 2.2\Omega$		130		
E_{on}	Turn-on Switching Energy ^⑥	INDUCTIVE SWITCHING @ 25°C $V_{DD} = 433V, V_{GS} = 15V$ $I_D = 97A, R_G = 2.2\Omega$		2860		μJ
E_{off}	Turn-off Switching Energy			3500		
E_{on}	Turn-on Switching Energy ^⑥	INDUCTIVE SWITCHING @ 125°C $V_{DD} = 433V, V_{GS} = 15V$ $I_D = 97A, R_G = 2.2\Omega$		4030		
E_{off}	Turn-off Switching Energy			3695		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_s	Continuous Source Current (Body Diode)			97	Amps
I_{SM}	Pulsed Source Current ^② (Body Diode)			291	
V_{SD}	Diode Forward Voltage ^④ ($V_{GS} = 0V, I_s = -48.5A$)		0.9	1.2	Volts
$\frac{dv}{dt}$	Peak Diode Recovery $\frac{dv}{dt}$ ^⑦			50	V/ns
t_{rr}	Reverse Recovery Time ($I_s = -97A, \frac{di}{dt} = 100A/\mu s$)	$T_j = 25^\circ C$		790	ns
Q_{rr}	Reverse Recovery Charge ($I_s = -97A, \frac{di}{dt} = 100A/\mu s$)	$T_j = 25^\circ C$		19	μC
I_{RRM}	Peak Recovery Current ($I_s = -97A, \frac{di}{dt} = 100A/\mu s$)	$T_j = 25^\circ C$		43	Amps

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R_{8JC}	Junction to Case			0.145	$^\circ C/W$
R_{8JA}	Junction to Ambient			40	

1 Continuous current limited by package lead temperature.

4 Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

2 Repetitive Rating: Pulse width limited by maximum junction temperature

5 See MIL-STD-750 Method 3471

3 Repetitive avalanche causes additional power losses that can be calculated as

6 Eon includes diode reverse recovery.

$P_{AV} = E_{AR} * f$. Pulse width tp limited by T_j max.

7 Maximum 125°C diode commutation speed = di/dt 600A/ μs

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

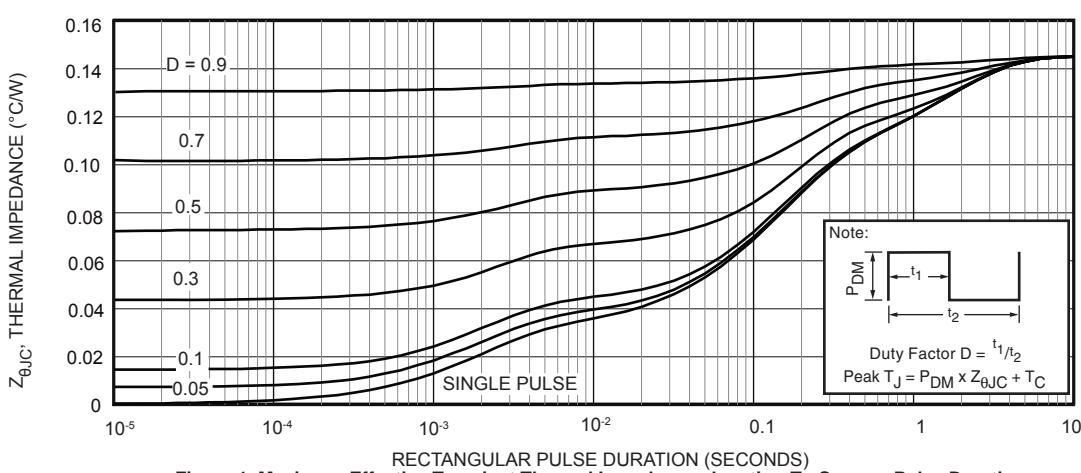
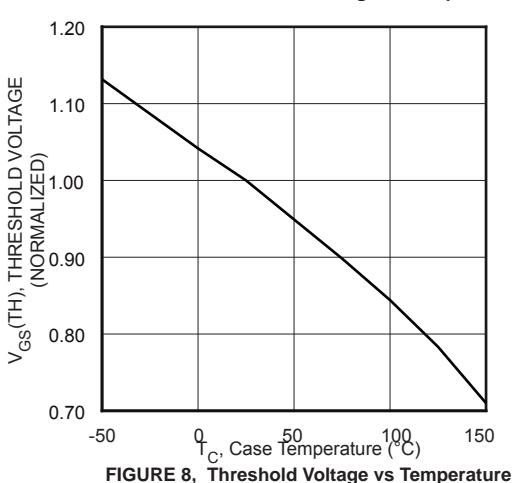
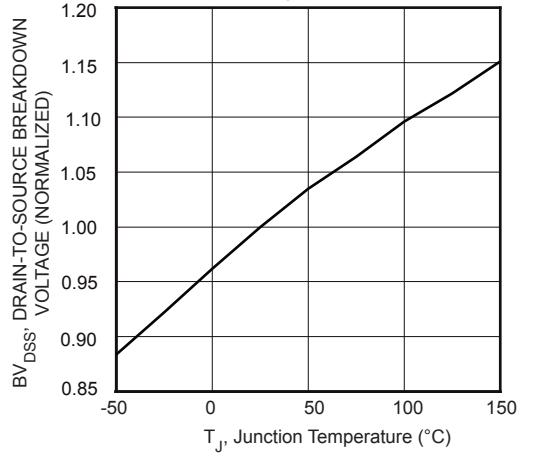
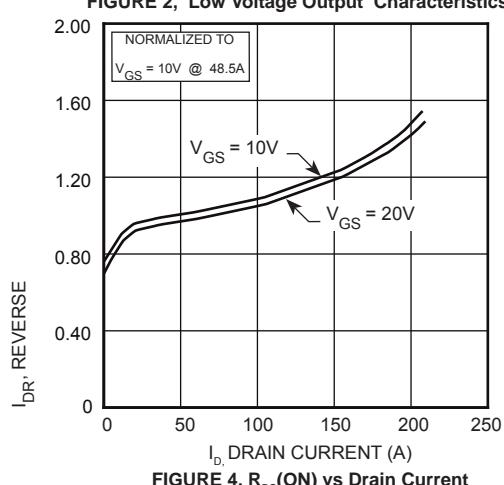
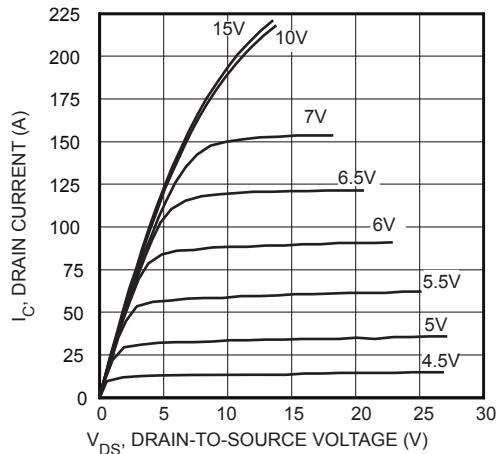
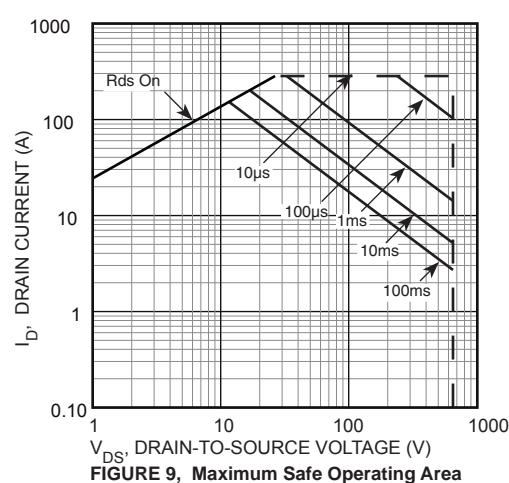
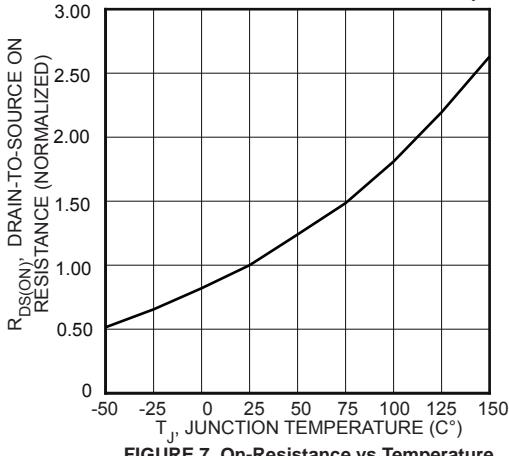
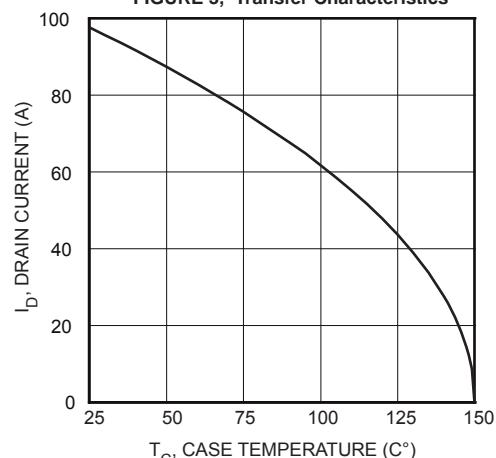
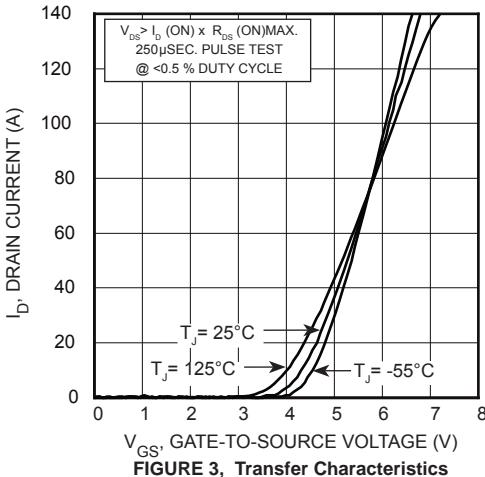


Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

Typical Performance Curves



APT97N65B2_LC6



Typical Performance Curves

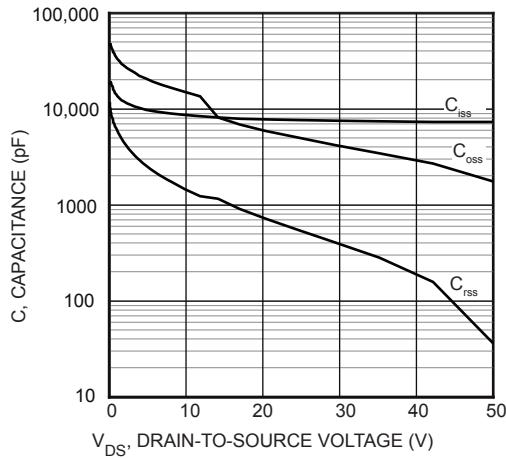


FIGURE 10, Capacitance vs Drain-To-Source Voltage

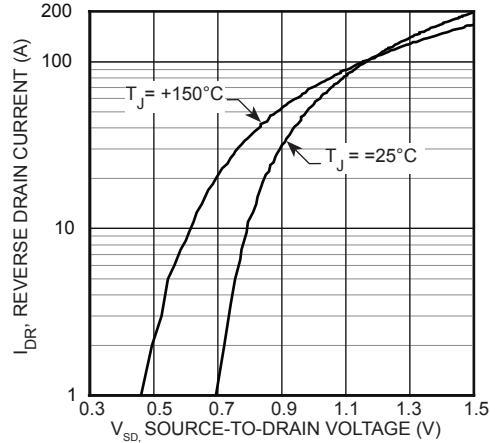


FIGURE 12, Source-Drain Diode Forward Voltage

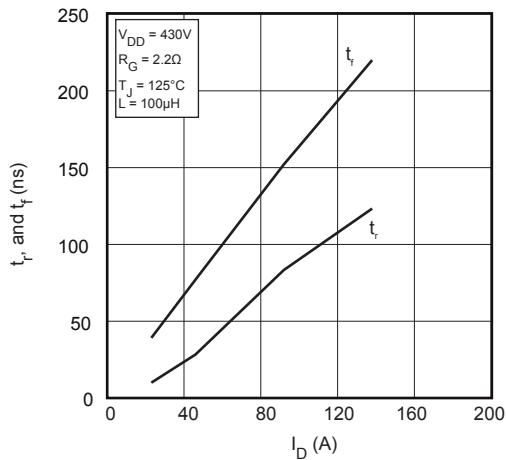


FIGURE 14 , Rise and Fall Times vs Current

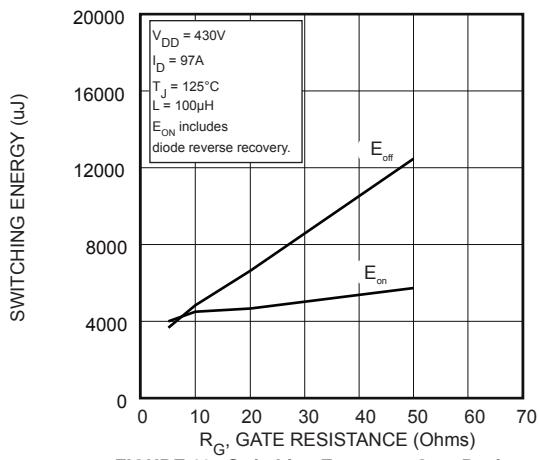


FIGURE 16, Switching Energy vs Gate Resistance

APT97N65B2_LC6

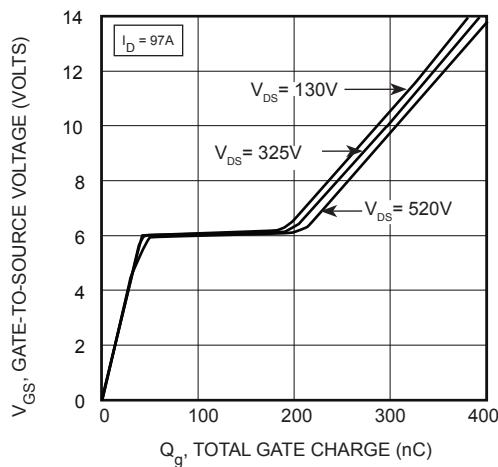


FIGURE 11, Gate Charges vs Gate-To-Source Voltage

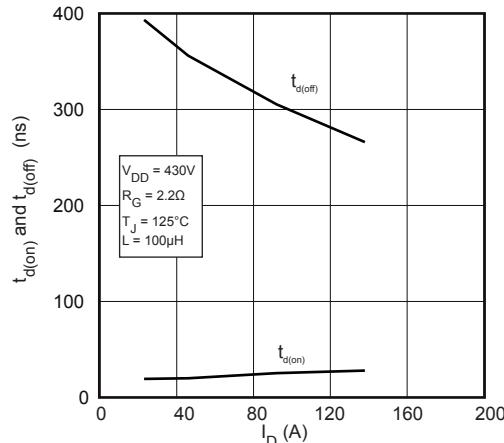


FIGURE 13, Delay Times vs Current

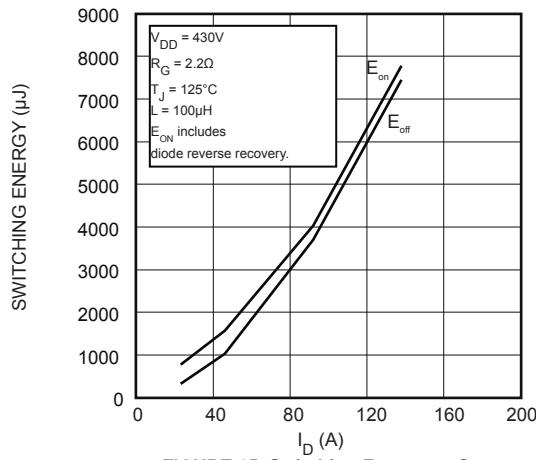


FIGURE 15, Switching Energy vs Current

Typical Performance Curves

APT97N65B2_LC6

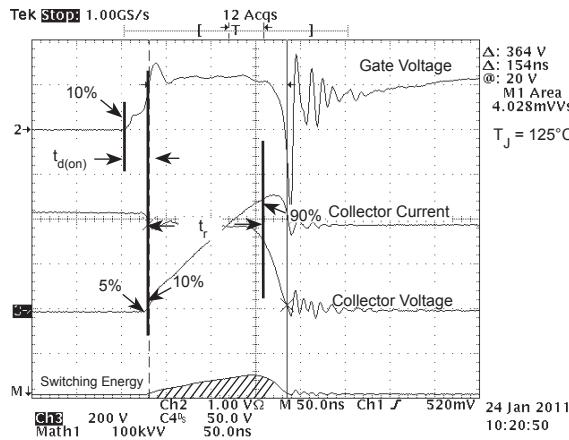


Figure 17, Turn-on Switching Waveforms and Definitions

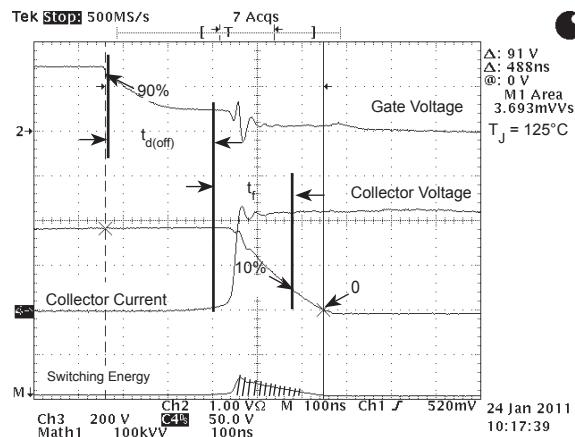


Figure 18, Turn-off Switching Waveforms and Definitions

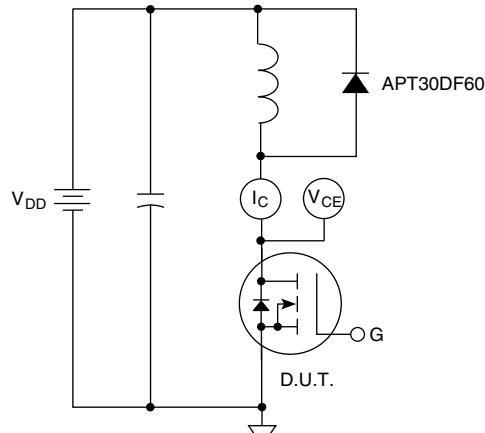
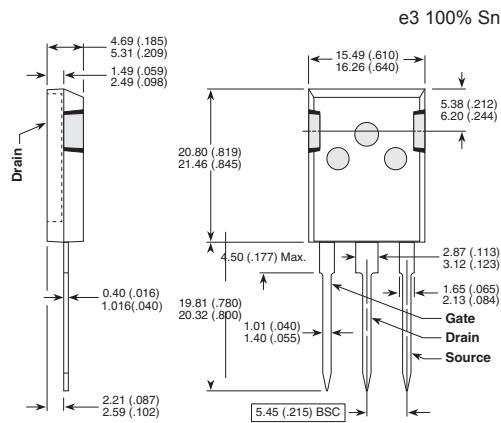


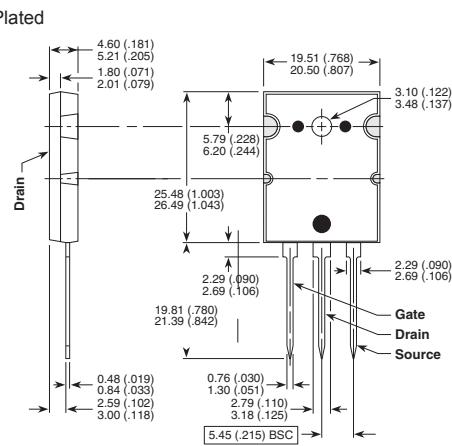
Figure 19, Inductive Switching Test Circuit

T-MAX® (B2) Package Outline



These dimensions are equal to the TO-247 without the mounting hole.

TO-264 (L) Package Outline





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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